

# Interface Electronics



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DESY-FEB

PSI, April 1<sup>st</sup> 2014

- > Brief status and news
- > Firmware/FPGA ..... Q. Xia, I Sheviakov

## Analogue mother board:

- 3 in hand with old gain
- 7 in hand with up-to-date gain
- 10 in production, ready in April

## Analogue daughter

- 10 in hand
- 3 in production
- ( 7 more empty PCB's)

## 2 slot backplanes

12 in hand (basic tests)

## 8 slot backplane

2 in hand and

3 none populated boards.



- **Micro controller:** Circuit diagram is done

Vybrid with  
ARM cortex A5/M4  
as SOM (system on  
module)

busses

- 2x SPI-bus to FPGA control board
- I<sup>2</sup>C branches to interface modules, vacuum-boards, FPGA control
- Ethernet to external control system
- SD-card, RS232, JTAG for internal debug

functions

- 8 isolated voltage supplies 5V/100mA for the 8 Vacuum boards
- 12 fans with each 300mA/-12V  
can be put in parallel for fewer stronger fans.  
I-settable, turn and U monitored
- Internal U, I, T, humidity monitored

layout

- mechanical options to put connectors straight or parallel to digital boards. Prices mech.design and wires  
Fallback option: Few Fan-power to a parallel board to digital part

**Additional options NOW!!!!!!!!!!!!!!!!!!!!**

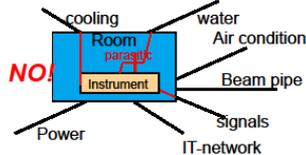
## Making the construction independent of currents in the GND system EMI-zoning Main conceptual system issue!!!!

Goal: minimize the coupling between different areas, functions

- Minimize  $Z_K$
- Maximize  $Z_E$

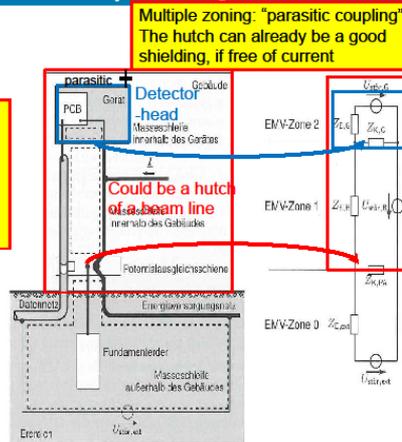
### Minimize $Z_K$ (room planning)

- All conductive connections at ONE point to instrument, to room, to building
- Afterwards/before distances to limit crosstalk
- Hard to get, than apply filters



Why not?

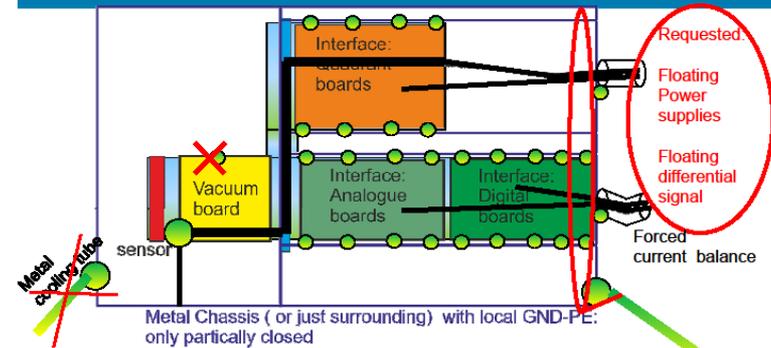
- Isolations for cooling, water, air, IT
- Short distance power, signals at ENTRANCE, not full length



J. Franz, EMV, ISBN 978-3-8348-0893-6  
Bild 7.32: Masseschleifen in einer Anlage nach ESB

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## Keeping GND free of currents: AGIPD-plans



Using floating power supplies forces the currents to go to the power supply  
Without using the general metal structures on PE.

Voltage drops on the metal of the detector are generated only by the fraction of none controlled currents. They will be there!

⇒ They don't generate currents within the external metal PE system, if only a small area provides the metal contacts to the outer world.

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## Options from our electronics

- Guided return currents with limited flow in PE-system
- Local current returns of parasitic currents to PE with option to open.
- Differential signaling
- But everything is limited and not perfect  
=> Doing now a mechanical/electrical concept to have low impact from and to others is realistic, later changes even for studies are major efforts.

The concept for industrial side planning is unlikely to be used for the XFEL-hutch planning:  
“It is task of experiment to get itself independent”





Item on Agenda is

Firmware for .....



# Making the construction independent of currents in the GND system

## EMI-zoning

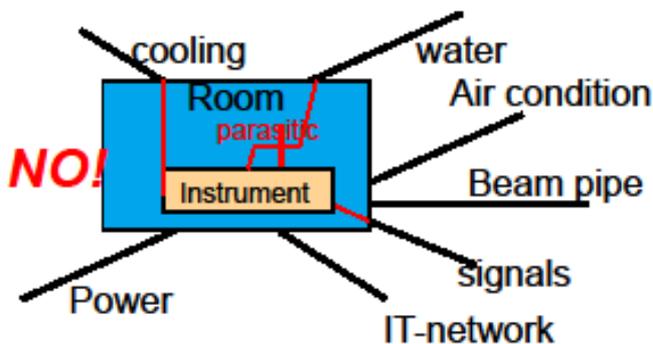
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**Minimize  $Z_K$  (room planning)**

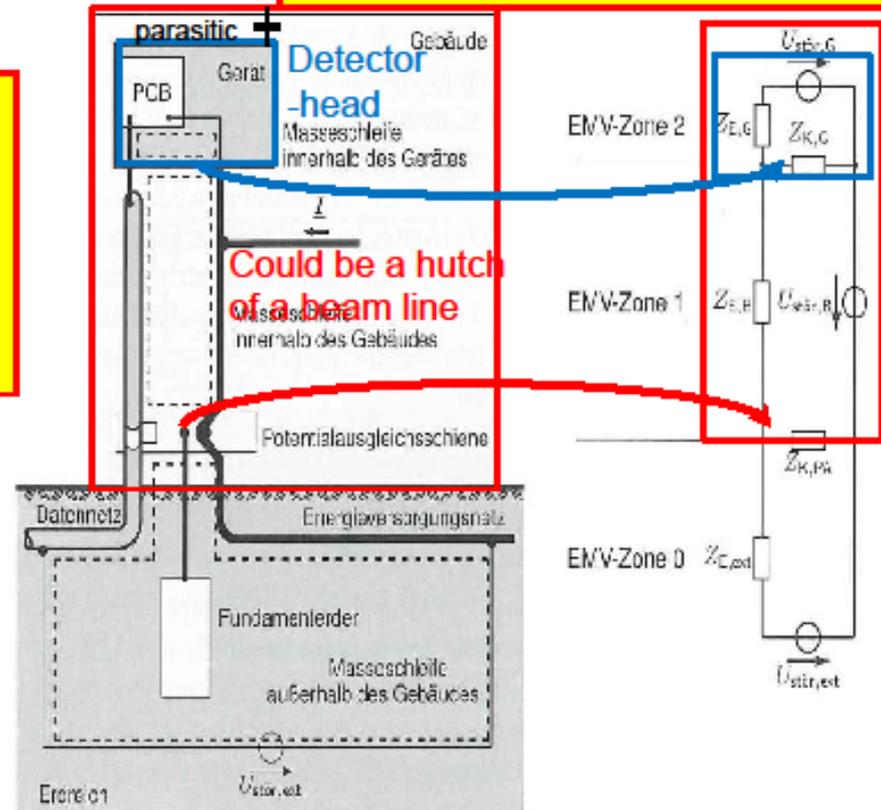
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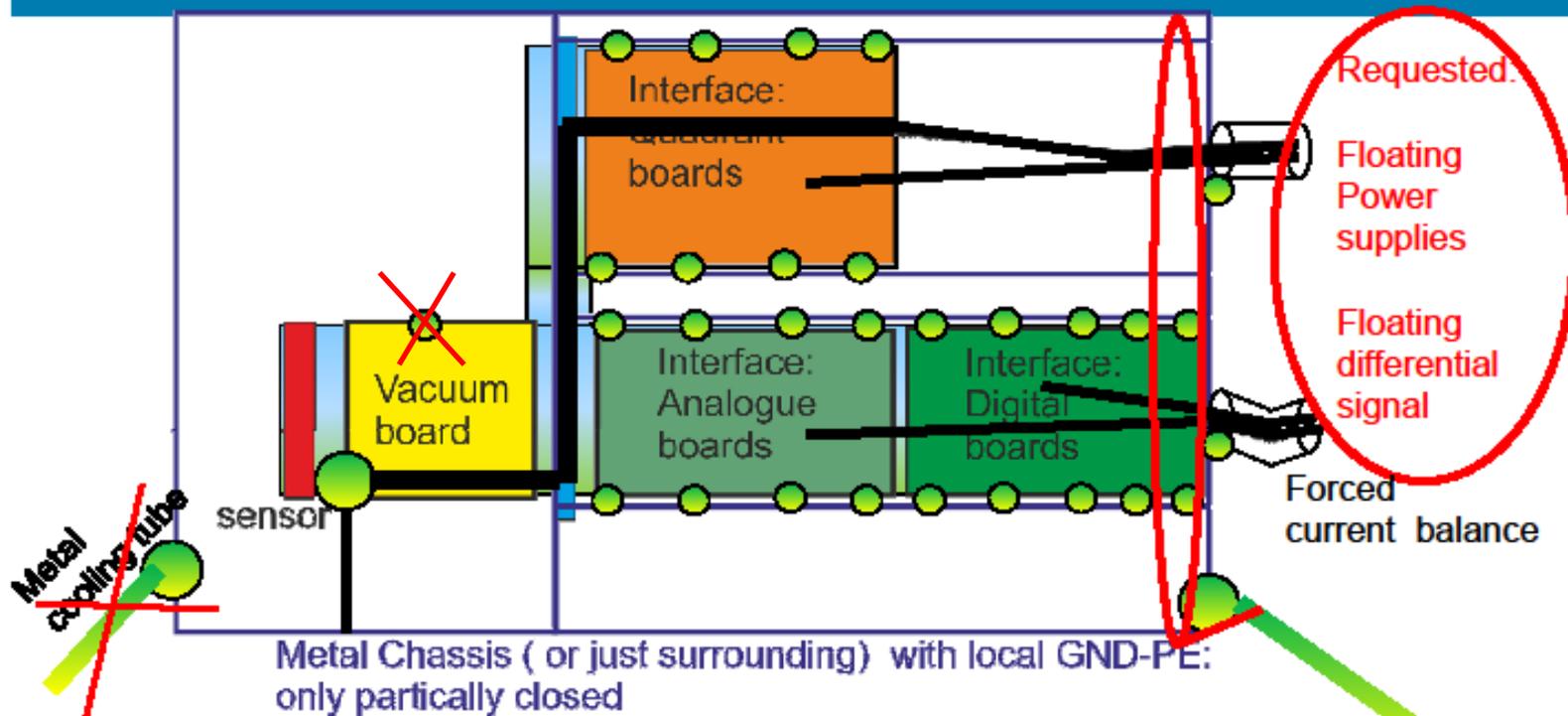
**Multiple zoning: "parasitic coupling"**  
The hutch can already be a good shielding, if free of current



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